

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

1-22. (canceled).

23. (new) A filter comprising:

- a) a first ceramic dielectric layer;
- b) a second ceramic dielectric layer;
- c) a third ceramic dielectric layer, the dielectric layers stacked on each other to form a multi-layered ceramic dielectric block;
- d) the block having a top surface formed by the first layer and a bottom surface formed by the third layer, the block having parallel opposed first and second side surfaces and parallel opposed third and fourth side surfaces;
- e) a first terminal located on the first side surface and having a first portion wrapping around onto the top surface, the bottom surface, the third side surface and the fourth side surface;
- f) a second terminal located on the second side surface and having a second portion wrapping around onto the top surface, the bottom surface, the third side surface and the fourth side surface;
- g) a third terminal located on the third side surface and having a third portion wrapping around onto the top and bottom surfaces;
- h) a fourth terminal located on the fourth side surface and having a fourth portion wrapping around onto the top and bottom surfaces;

- i) a first metal plate located between the first and second ceramic dielectric layers, the first metal plate electrically connected to the first terminal;
- j) a second metal plate located between the first and second ceramic dielectric layers, the second metal plate electrically connected to the second terminal;
- k) a ground plane located within the dielectric block between the second and third ceramic dielectric layers, the ground plane overlapping the first and second portions, the ground plane further overlapping the third and fourth portions;
- l) a first capacitor being formed by the first metal plate, the second ceramic dielectric layer and the ground plane, the first metal plate overlapping the ground plane; and
- m) a second capacitor being formed by the second metal plate, the second ceramic dielectric layer and the ground plane, the second metal plate overlapping the ground plane.

24. (new) The filter according to claim 23, wherein a via connects the ground plane to the third and fourth terminals.

25. (new) The filter according to claim 23, wherein the capacitors improve isolation between the first and second terminals.

26. (new) The filter according to claim 23, wherein the terminals are formed by screen printing a metal conductor.

27. (new) The filter according to claim 23, wherein the first metal plate, the second metal plate and the ground plane are formed by screen printing a metal conductor.

28. (new) A filter comprising:

- a) a first ceramic dielectric layer;
- b) a second ceramic dielectric layer;
- c) a third ceramic dielectric layer, the dielectric layers stacked on each other to form a multi-layered ceramic dielectric block;
- d) the block having a top surface formed by the first layer and a bottom surface formed by the third layer, the block having parallel opposed first and second side surfaces and parallel opposed third and fourth side surfaces;
- e) a first terminal located on the first side surface and having a first portion wrapping around onto the top surface, the bottom surface, the third side surface and the fourth side surface;
- f) a second terminal located on the second side surface and having a second portion wrapping around onto the top surface, the bottom surface, the third side surface and the fourth side surface;
- g) a third terminal located on the third side surface and having a third portion wrapping around onto the top and bottom surfaces;
- h) a fourth terminal located on the fourth side surface and having a fourth portion wrapping around onto the top and bottom surfaces;
- i) a first metal plate located between the first and second ceramic dielectric layers, the first metal plate electrically connected to the first terminal;
- j) a second metal plate located between the first and second ceramic dielectric layers, the second metal plate electrically connected to the second terminal;

- k) a ground plane located within the dielectric block between the second and third ceramic dielectric layers, the ground plane having a length and a width, the length of the ground plane being less than the distance between the first and second portions such that the ground plane does not overlap the first portion and such that the ground plane does not overlap the second portion, the ground plane further overlapping the third and fourth portions;
- l) a first capacitor being formed by the first metal plate, the second ceramic dielectric layer and the ground plane; and
- m) a second capacitor being formed by the second metal plate, the second ceramic dielectric layer and the ground plane.

29. (new) The filter according to claim 28, wherein a via connects the ground plane to the third and fourth terminals.

30. (new) The filter according to claim 28, wherein the capacitors improve isolation between the first and second terminals.

31. (new) The filter according to claim 28, wherein the ground plane improves isolation between the first and second terminals.

32. (new) The filter according to claim 28, wherein the terminals are formed by screen printing a metal conductor.

33. (new) The filter according to claim 28, wherein the first metal plate, the second metal plate and the ground plane are formed by screen printing a metal conductor.